



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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FO connectors - FOC-V14-C1ZNI-S/SJFG - 1407898

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Push-pull connector (version 14), die-cast zinc, with SC-RJ insert for GOF, for cable diameter of 5.5 mm ... 10 mm

Product Features

- Push-pull ADVANCE connector
- Locking system to prevent inadvertent removal
- Highest ESD and EMC resistance for reliable transmission



Key Commercial Data

Packing unit	1 pc
Custom tariff number	85367000
Country of origin	Germany

Technical data

Mechanical characteristics

Standards/specifications	IEC PAS 61076-3-117
Insertion/withdrawal cycles	≥ 50
External cable diameter	5.5 mm ... 10 mm

Ambient conditions

Ambient temperature (operation)	-40 °C ... 70 °C
Ambient temperature (assembly)	-10 °C ... 40 °C
Ambient temperature (storage/transport)	-40 °C ... 70 °C

Material data

Housing material	Zinc die-cast
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Standards and Regulations

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Technical data

Standards and Regulations

Standards/regulations	IEC PAS 61076-3-117
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Classifications

eCl@ss

eCl@ss 4.0	27140816
eCl@ss 4.1	27260701
eCl@ss 5.0	27260701
eCl@ss 5.1	27061803
eCl@ss 6.0	27260708
eCl@ss 7.0	27440312
eCl@ss 8.0	19170122

ETIM

ETIM 3.0	EC001121
ETIM 4.0	EC000034
ETIM 5.0	EC001122

UNSPSC

UNSPSC 6.01	31261501
UNSPSC 7.0901	31261501
UNSPSC 11	31261501
UNSPSC 12.01	31261501
UNSPSC 13.2	31261501

Drawings

Dimensional drawing



